

### **AMENDMENTS TO THE SPECIFICATION**

Please amend the specification on page 2, by inserting the following paragraph after line 21:

--FIGURE 5(c) is a cross-section view of a portion of a flexible substrate mounted on a flexible support showing a portion of a protective layer encapsulating the electrical connection;--

Please amend the paragraph beginning at page 9, line 5 as follows:

--FIGURE 5(b) depicts a portion of one embodiment of a CE incorporating a sensor module 510 as part of its shell. In one embodiment, sensor module 510 may include each of the components illustrated in FIGURE 5(a). For example, using support 502 and substrate 501 of Fig. 5(a), the electrical connections are encapsulated by protective layer 506 (e.g., a moisture resistant epoxy), a portion of which is illustrated in FIGURE 5(b). Support 502 and substrate 501 are curved into a contour that matches the desired surface of a CE shell.--

Please amend the specification on page 9, by inserting the following paragraph after line 9:

--FIGURE 5(c) illustrates a portion of the sensor for one embodiment, which a portion of substrate 501 coupled with support 502, and protective layer 506, where the electrical connections are encapsulated by protective layer 506.--

Please amend the paragraph beginning at Page 9, line 10 as follows:

--FIGURE 6 shows a view of a rigid support having a preformed mounting surface with a curved mounting surface, in accordance with aspects of the present invention. This embodiment makes use of a rigid support structure (602) having a curved surface portion of the rigid support, and substrate 601. Embodiments can assume a number of different shapes. Such rigid supports can be formed of a multitude of different materials including, but not limited to ceramics and plastics.--